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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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QT-Brightek Corporation

ZERO-CROSSING TRIAC OPTOCOUPLER

Part No.: Q303X/ Q304X/ Q306X/ Q308X series

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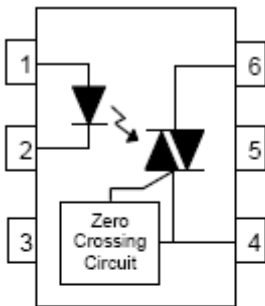
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Introduction

Feature:

- High Isolation voltage between input and output (Viso = 5000V rms)
- Zero voltage crossing
- Operating Temperature up to 100 °C
- Available in Tube or Tape and reel
- Available with standard DIP-6, Wide lead bend, and SMD lead bend options.
- Conventional black housing package

Schematic:



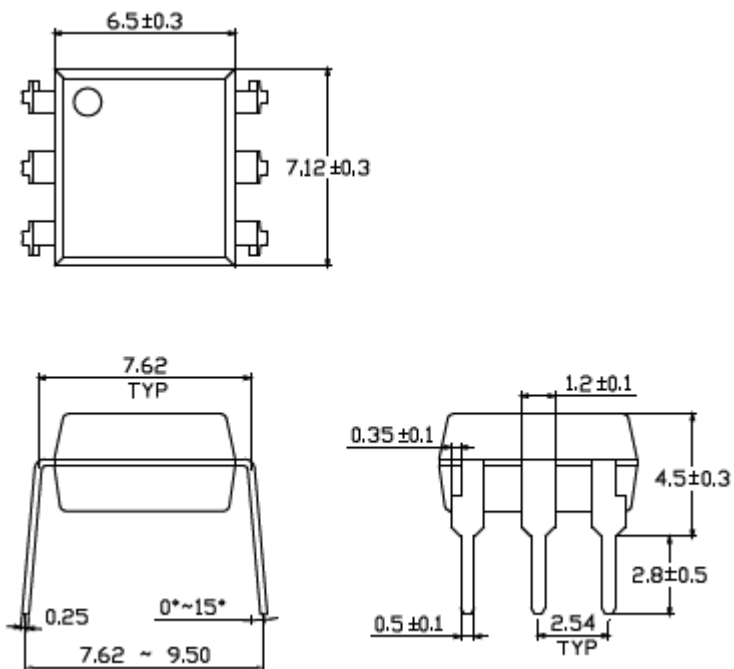
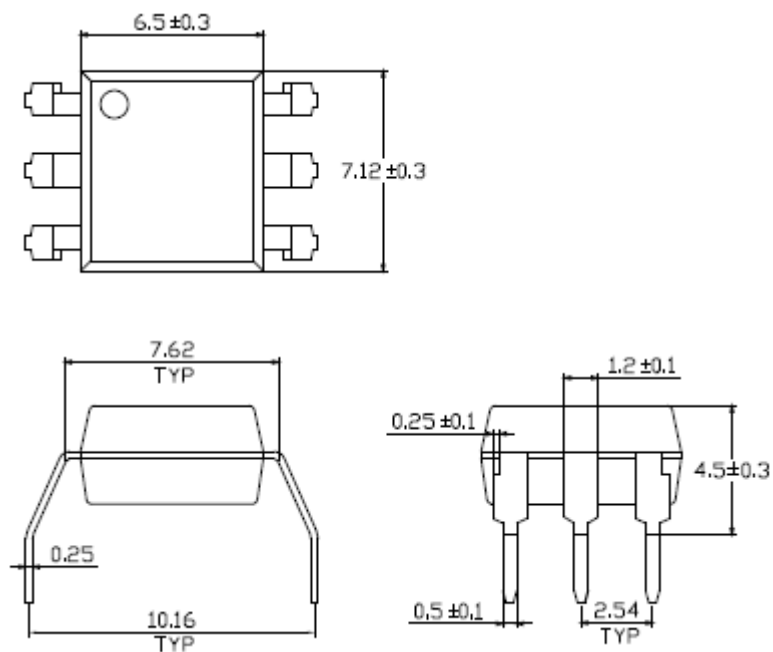
Pin Configuration

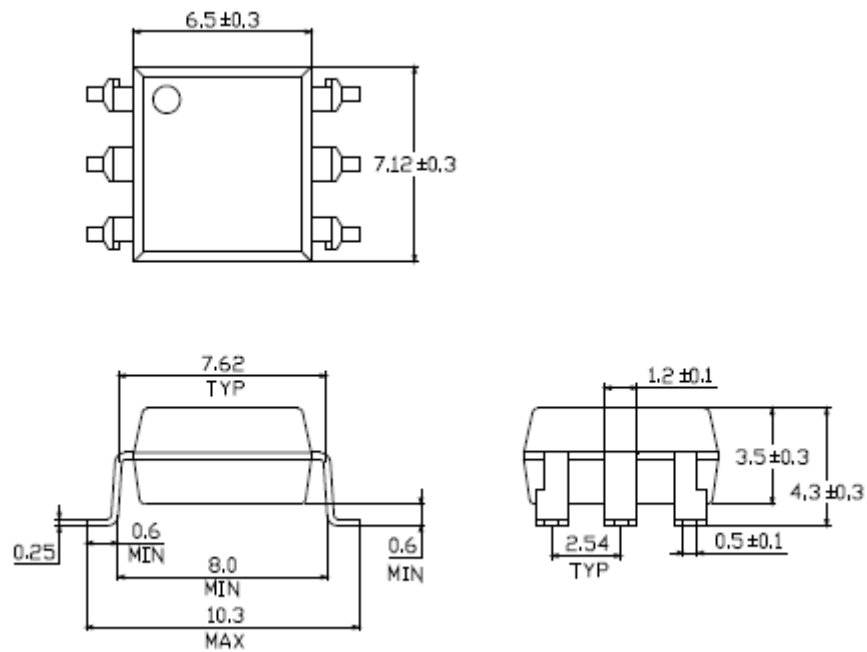
1. Anode
2. Cathode
3. No Connection
4. Terminal
5. Substrate
(do not connect)
6. Terminal

Certification & Compliance:

- Pb free and RoHS Compliant
- UL recognized (File # E338132)
- VDE recognized (File # 40030457)



Dimension:**6-Pin Dip (standard):****Wide lead bend (Option W):**

SMD lead bend (Option S):

All Dimensions are in mm
Tolerance = +/- 0.1mm

Absolute Maximum Rating

Symbol	Parameter	Rating	Units	
T _{STG}	Storage Temperature	-55 ~ 150	°C	
T _{OPR}	Operating Temperature	-55 ~ 100	°C	
T _{SOL}	Lead Solder Temperature	260 for 10 sec	°C	
P _{TOT}	Total Power Dissipation	250	mW	
EMITTER				
I _F	Continuous Forward Current	60	mA	
V _R	Reverse Voltage	6	V	
P _D	Power Dissipation	100	mW	
	Power Dissipation Derated above 25°C	1.41	mW/°C	
DETECTOR				
P _D	Power Dissipation	300	mW	
	Power Dissipation Derated above 25 °C	1.76	mW/°C	
V _{DRM}	Off-state Output Terminal Voltage	Q303X series	250	V
		Q304X series	400	
		Q306X series	600	
		Q308X series	800	
I _{TSM}	Peak Repetitive Surge Current	1	A	

Electrical Characteristic (T=25 °C)

Emitter

Symbol	Characteristic	Test Condition	Range			Unit
			Min	Typ	Max	
V_F	Forward Voltage	$I_F = 30\text{mA}$	-	-	1.5	V
I_R	Reverse Current	$V_R = 6\text{V}$	-	-	10	μA

Detector

Symbol	Characteristic	Device	Test Condition	Range			Unit
				Min	Typ	Max	
$I_{\text{DRM-1}}$	Peak Blocking Current	Q303X /Q304X series	$V_{\text{DRM}} = \text{Rated } V_{\text{DRM}},$ $I_F = 0\text{mA}$	-	-	100	nA
		Q306X /Q308X series		-	-	500	
$I_{\text{DRM-2}}$	Leakage in inhibited state		$I_F = \text{Rated } I_{\text{FT}},$ $V_{\text{DRM}} = \text{Rated } V_{\text{DRM}},$ off state	-	-	500	μA
V_{TM}	Peak on-state voltage		$I_{\text{TM}} = 100\text{mA peak},$ $I_F = \text{Rated } I_{\text{FT}}$	-	-	3.0	V
dv/dt	Critical Rate of Rise off-state voltage	Q303X /Q304X /Q306X series	$V_{\text{PEAK}} = \text{Rated } V_{\text{DRM}},$ $I_F = 0$ (refer to test circuit for dv/dt)	1000	-	-	V/ μs
		Q308X series		600	-	-	
V_{INH}	Inhibit voltage		$I_F = \text{rated } I_{\text{FT}},$ MT1-MT2 voltage above which device will not trigger off-state	-	-	20	V

Transfer Characteristic:

Symbol	Characteristic	Device	Test Condition	Range			Unit
				Min	Typ	Max	
I _{FT}	LED Trigger Current	Q3031	Main terminal voltage = 3V	-	-	15	mA
		Q3041		-	-		
		Q3061		-	-		
		Q3081		-	-	10	
		Q3032		-	-		
		Q3042		-	-		
		Q3062		-	-	5	
		Q3082		-	-		
		Q3033		-	-		
		Q3043					
		Q3063					
		Q3083					
I _H	Holding Current			-	280	-	μA
V _{ISO}	Isolation voltage			5000	-	-	V

Characteristic Curves

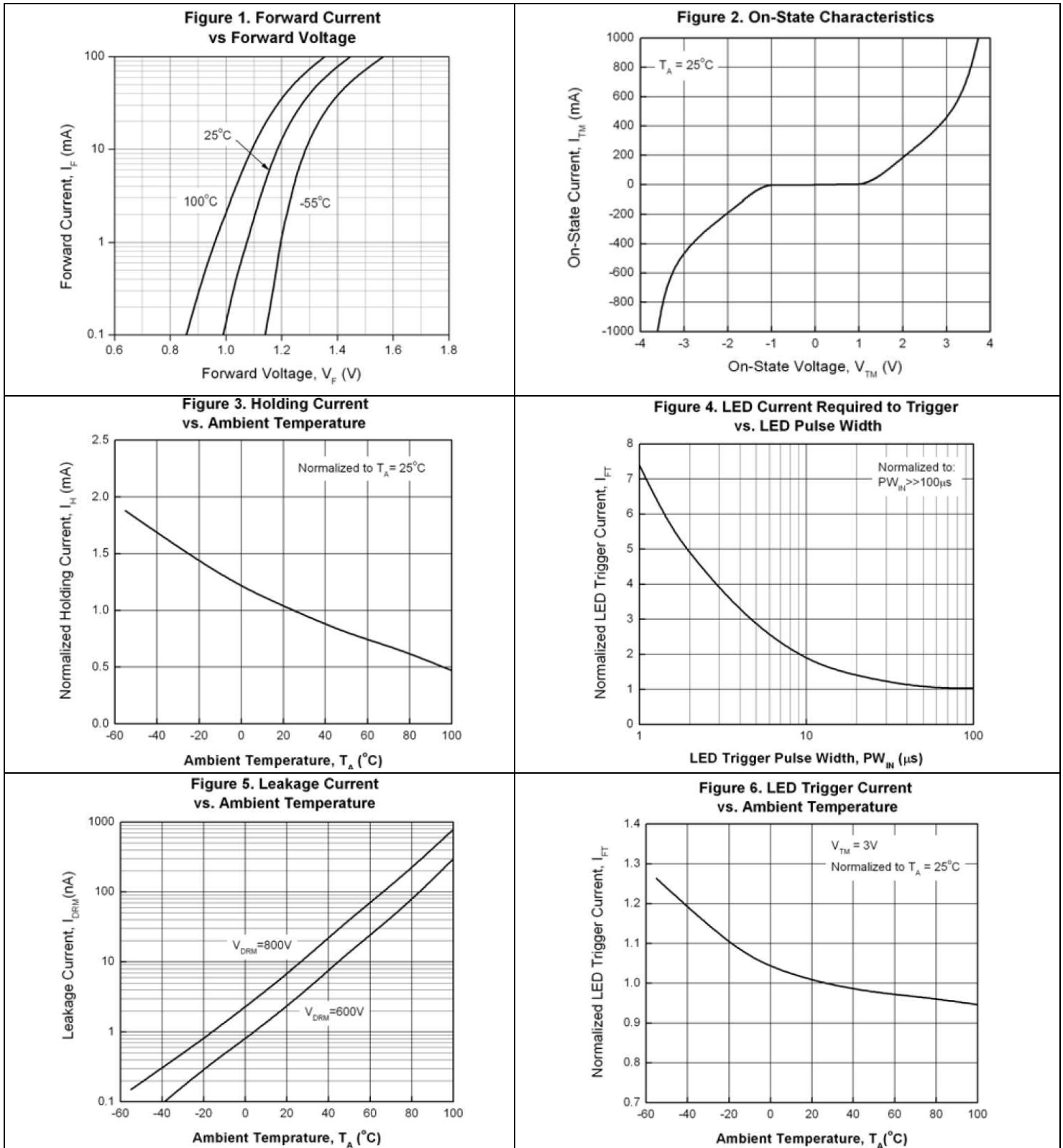


Figure 7. Off-State Output Terminal Voltage vs. Ambient Temperature

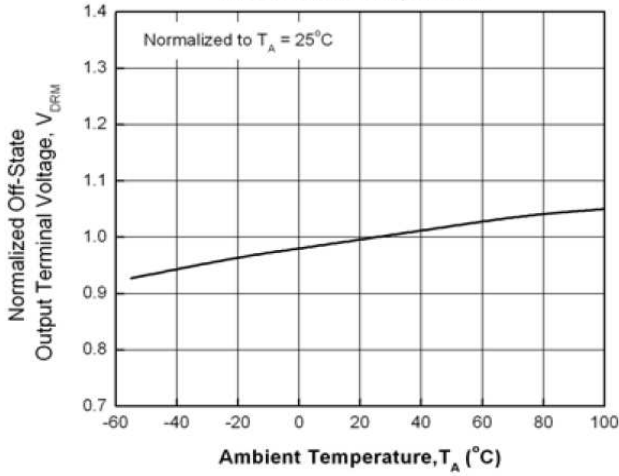


Figure 8. Leakage in Inhibit State vs. Ambient Temperature

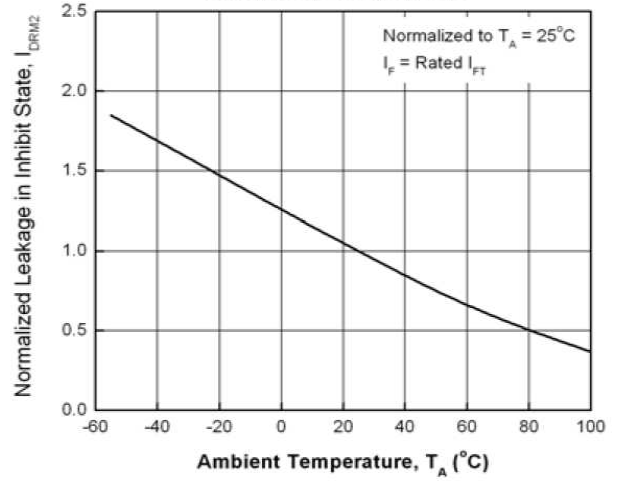
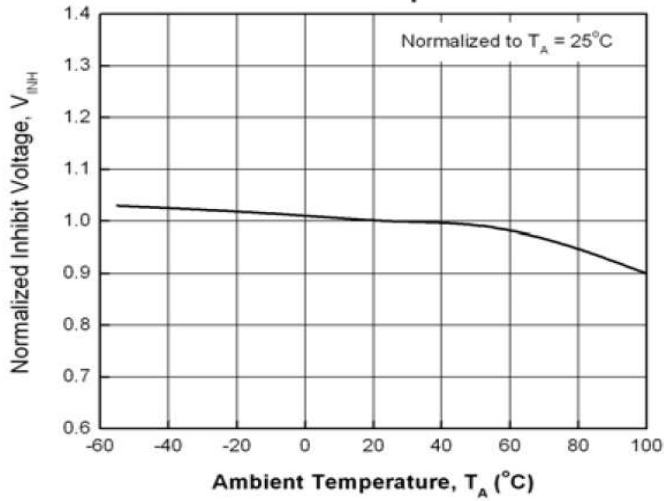
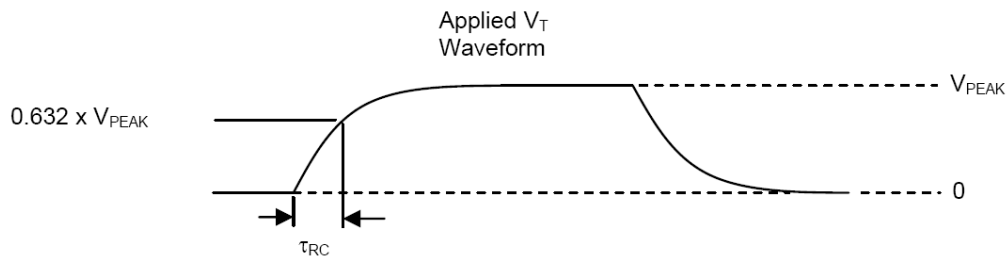
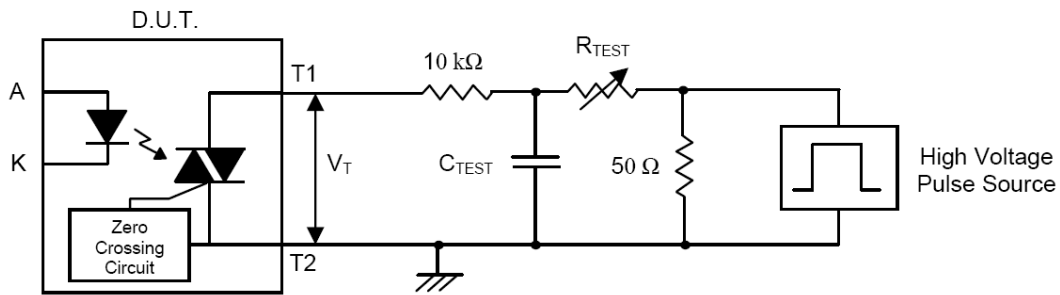


Figure 9. Inhibit Voltage vs. Ambient Temperature



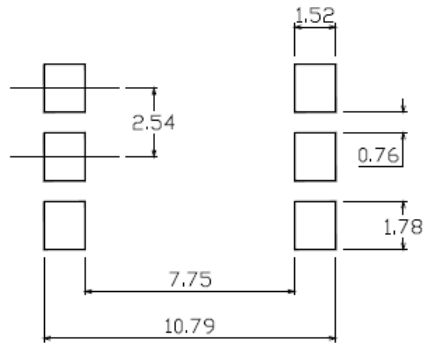
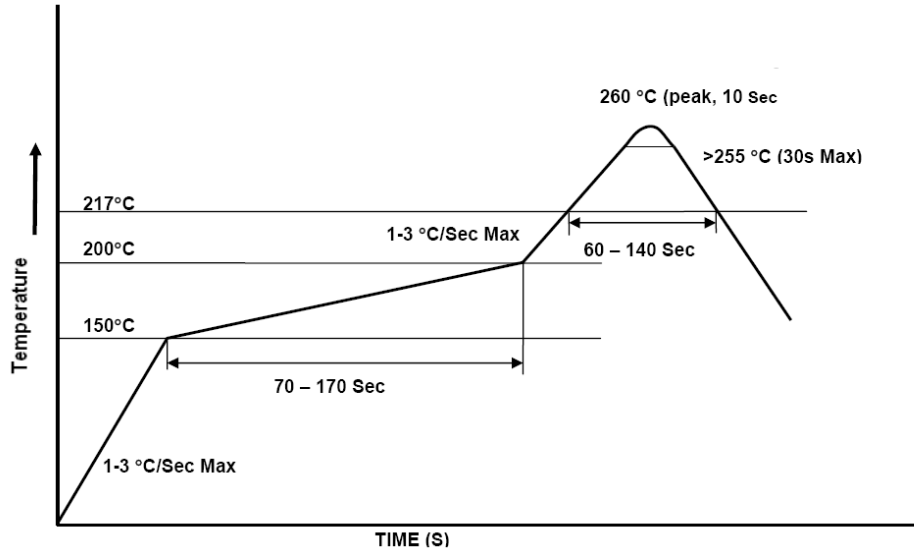
Test Circuit for static dv/dt



The high voltage pulse is set to the required V_{PEAK} value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform V_T is monitored using a x100 scope probe. By varying R_{TEST} , the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point, τ_{RC} is recorded and the dv/dt calculated.

$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

Solder Profile & Footprint



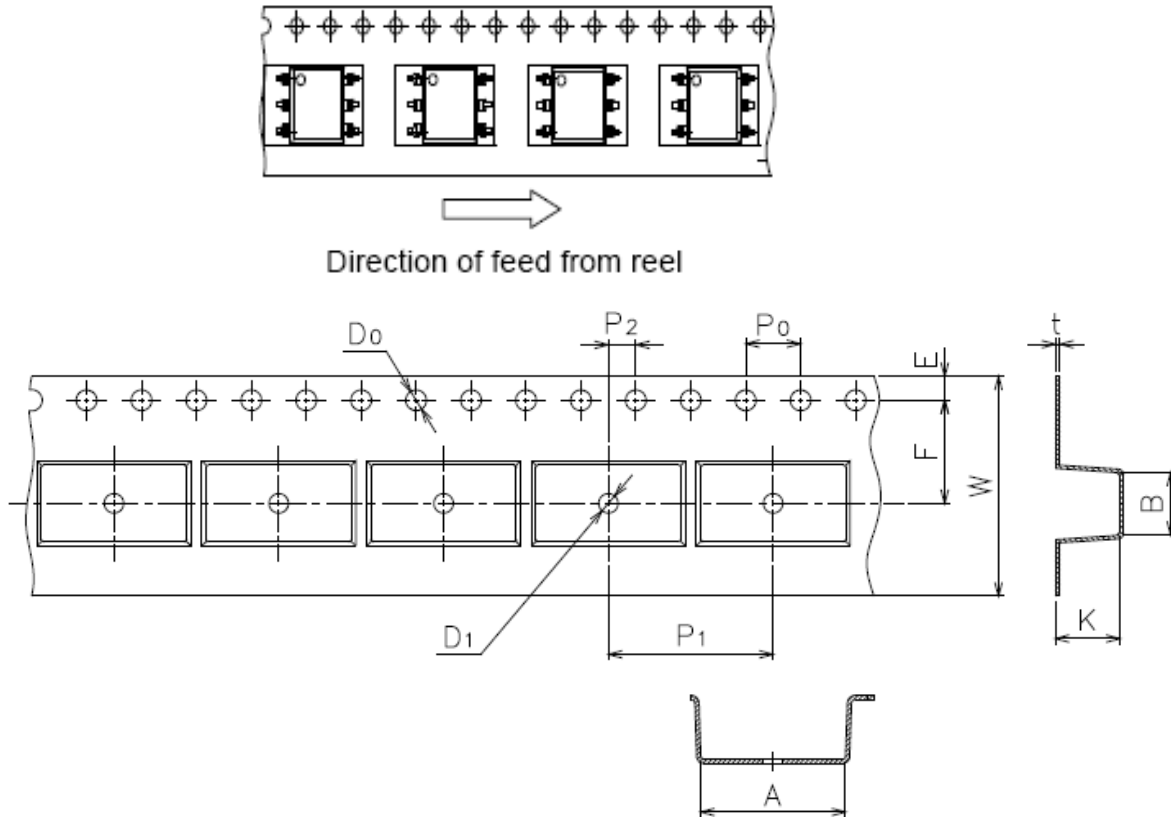
Recommended Solder Footprint for SMD Leadform

Units: mm

tolerance: +/- 0.1mm

Packing & Labeling

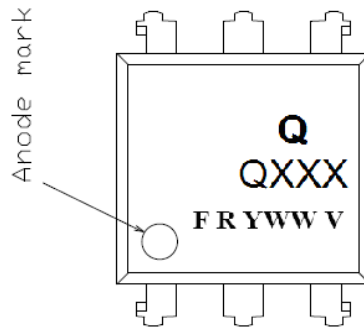
Tape Dimension:



Dimension No.	A	B	Do	D1	E	F
Dimension (mm)	10.4±0.1	7.52±0.1	1.5+0.1/-0	1.5+0.1/-0	1.75±0.1	7.5±0.1

Dimension No.	Po	P1	P2	t	W	K
Dimension (mm)	4.0±0.15	1.6±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1

Device Marking



Q = QT-Brightek Corporation
QXXX = Device Part Number
F = Country of Origin
R = Binning Option
Y = Year
WW = Week
V = VDE Option

Ordering Information

Part Number	Orderable Part Number	Options	Description	Quantity per packing
Q303X series	Q3031 / Q3032 / Q3033	None	Standard 6pin DIP	60pcs / Tube
	Q3031V / Q3032V / Q3033V	None	Standard 6 pin Dip + With VDE marking	60pcs / Tube
	Q3031W / Q3032W / Q3033W	W	Wide lead bend (0.4 inch spacing)	60pcs / Tube
	Q3031WV / Q3032WV / Q3033WV	W	Wide lead bend (0.4 inch spacing) + VDE marking	60pcs / Tube
	Q3031STA / Q3032STA / Q3033STA	S	SMD lead form with tape and reel option	1000pcs / reel
	Q3031STAV / Q3032STAV / Q3033STAV	S	SMD lead form with tape and reel option + VDE marking	1000pcs / reel
Q304X series	Q3041 / Q3042 / Q3043	None	Standard 6pin DIP	60pcs / Tube
	Q3041V / Q3042V / Q3043V	None	Standard 6 pin Dip + With VDE marking	60pcs / Tube
	Q3041W / Q3042W / Q3043W	W	Wide lead bend (0.4 inch spacing)	60pcs / Tube
	Q3041WV / Q3042WV / Q3043WV	W	Wide lead bend (0.4 inch spacing) + VDE marking	60pcs / Tube
	Q3041STA / Q3042STA / Q3043STA	S	SMD lead form with tape and reel option	1000pcs / reel
	Q3041STAV / Q3042STAV / Q3043STAV	S	SMD lead form with tape and reel option + VDE marking	1000pcs / reel
Q306X serie	Q3061 / Q3062 / Q3063	None	Standard 6pin DIP	60pcs / Tube
	Q3061V / Q3062V / Q3063V	None	Standard 6 pin Dip + With VDE marking	60pcs / Tube
	Q3061W / Q3062W / Q3063W	W	Wide lead bend (0.4 inch spacing)	60pcs / Tube
	Q3061WV / Q3062WV / Q3063WV	W	Wide lead bend (0.4 inch spacing) + VDE marking	60pcs / Tube
	Q3061STA / Q3062STA / Q3063STA	S	SMD lead form with tape and reel option	1000pcs / reel
	Q3061STAV / Q3062STAV / Q3063STAV	S	SMD lead form with tape and reel option + VDE marking	1000pcs / reel

Q308X series	Q3081 / Q3082 / Q3083	None	Standard 6pin DIP	60pcs / Tube
	Q3081V / Q3082V / Q3083V	None	Standard 6 pin Dip + With VDE marking	60pcs / Tube
	Q3081W / Q3082W / Q3083W	W	Wide lead bend (0.4 inch spacing)	60pcs / Tube
	Q3081WV / Q3082WV / Q3083WV	W	Wide lead bend (0.4 inch spacing) + VDE marking	60pcs / Tube
	Q3081STA / Q3082STA / Q3083STA	S	SMD lead form with tape and reel option	1000pcs / reel
	Q3081STAV / Q3082STAV / Q3083STAV	S	SMD lead form with tape and reel option + VDE marking	1000pcs / reel

Revision History

Description:	Revision #	Revision Date
Initial of Q303X/Q304X/Q306X/Q308X series	1.0	4/22/2010
Feature, certification & compliance and ordering information updates	1.1	02/01/2011
Update format	1.2	05/15/2013

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.